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(12) **United States Design Patent** (10) **Patent No.:** **US D932,452 S**
McBride et al. (45) **Date of Patent:** **** *Oct. 5, 2021**

(54) **SEMICONDUCTOR DEVICE** 4,951,124 A * 8/1990 Sawaya H05K 3/308
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(*) Notice: This patent is subject to a terminal disclaimer.

(**) Term: **15 Years**

(21) Appl. No.: **29/715,105**

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(51) **LOC (13) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/182**

(58) **Field of Classification Search**
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H01L 21/4846; H01L 21/4871; H01L 21/67144; H01L 2224/42; H01L 2224/43;
H01L 2224/01; H01L 2224/08055; H01L 2224/08054; H01L 23/12; H01L 23/13;
H01L 23/14; H01L 23/147; H01L 23/00;
H01L 23/48; H01L 23/4926; H01L 23/495; H01L 23/49517; H01L 23/498;
H01L 23/49805; H01L 23/49811; H01L 23/49861; H01L 23/49866; H01L 23/49872; H01L 23/49575; H01L 23/49579

See application file for complete search history.

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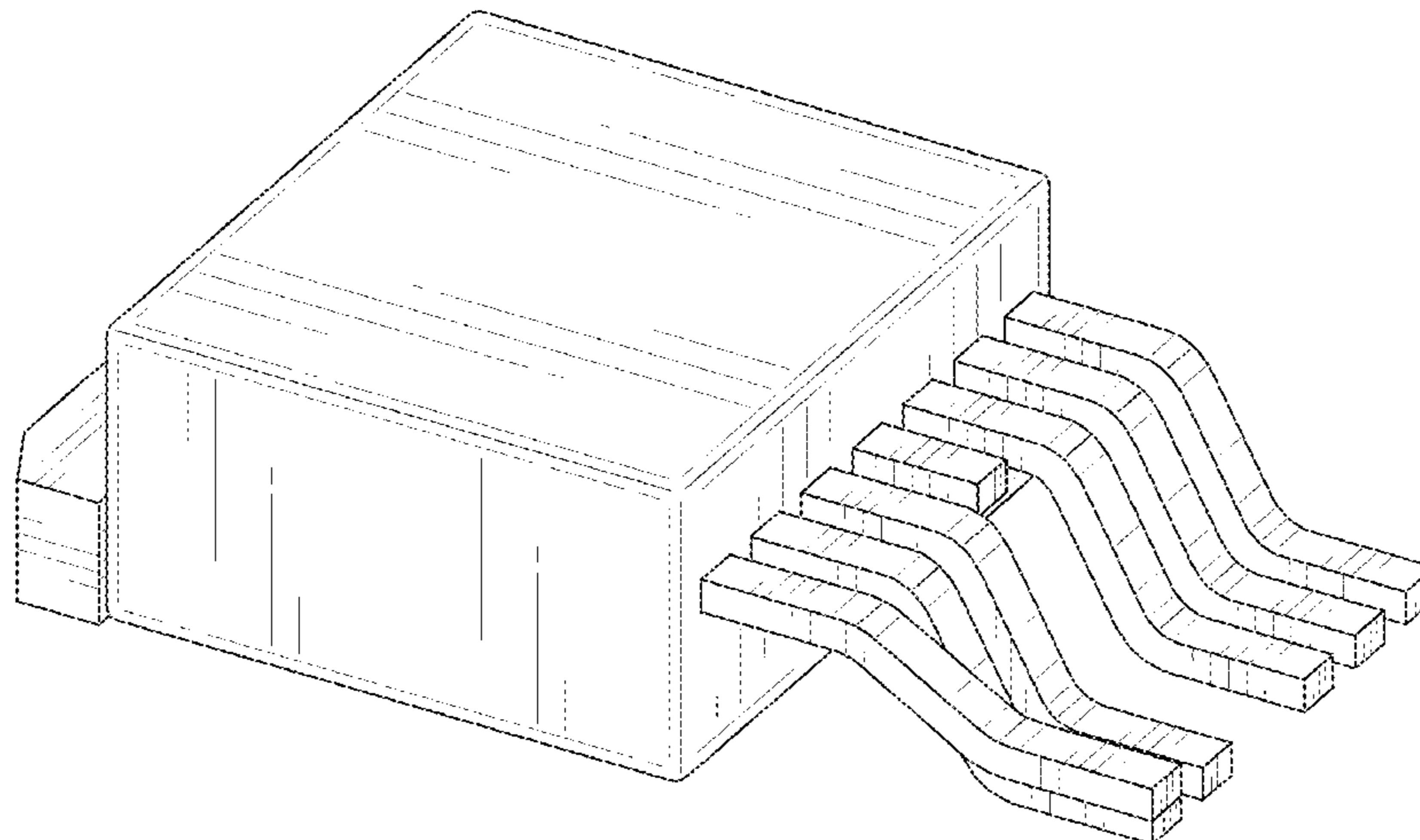
(57) **CLAIM**

The ornamental design for a semiconductor device, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a semiconductor device showing our new design;
FIG. 2 is a left side view thereof;
FIG. 3 is a right side view thereof;
FIG. 4 is a rear view thereof;
FIG. 5 is a front view thereof;
FIG. 6 is a top view thereof; and,
FIG. 7 is a bottom view thereof.

1 Claim, 7 Drawing Sheets



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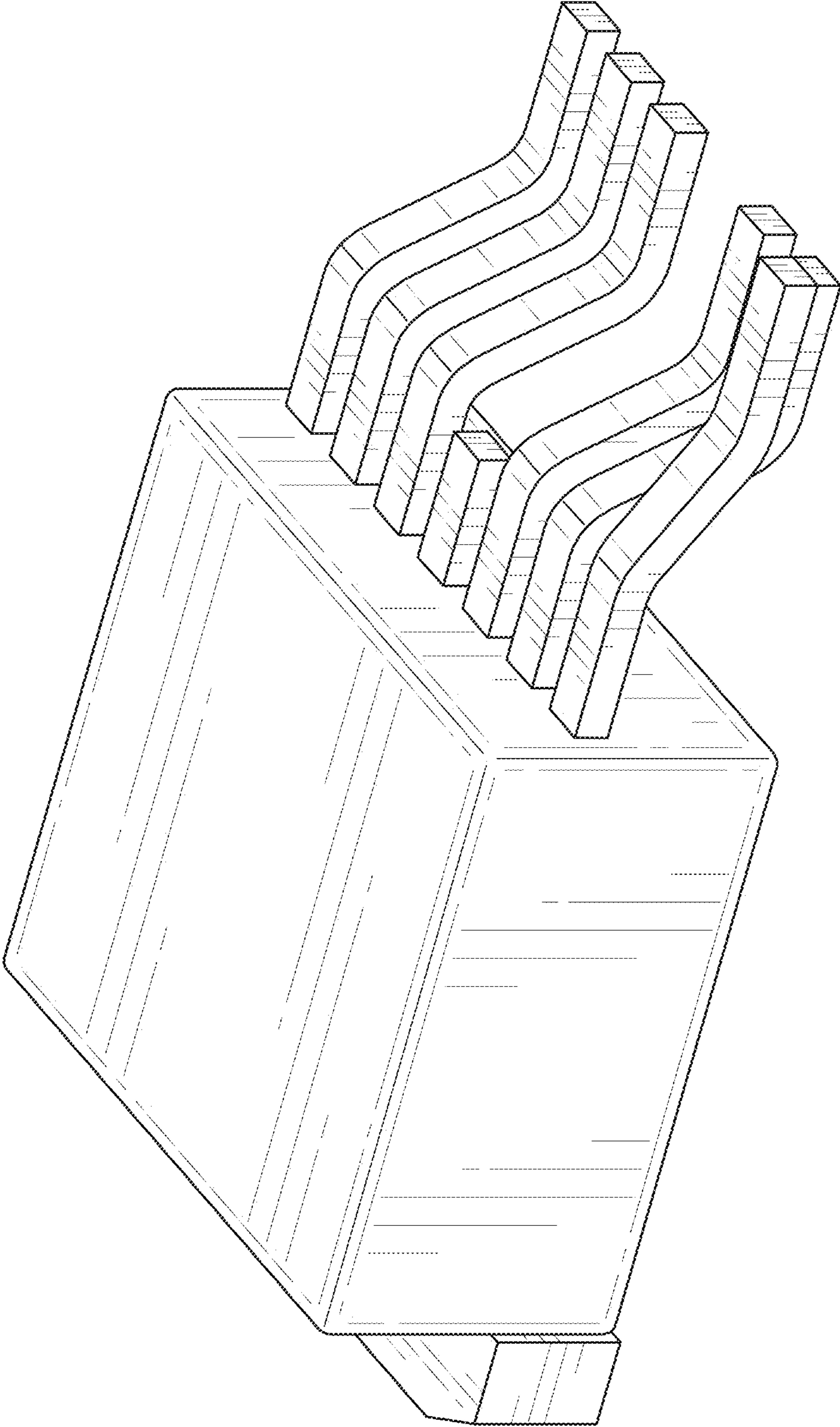


FIG. 1

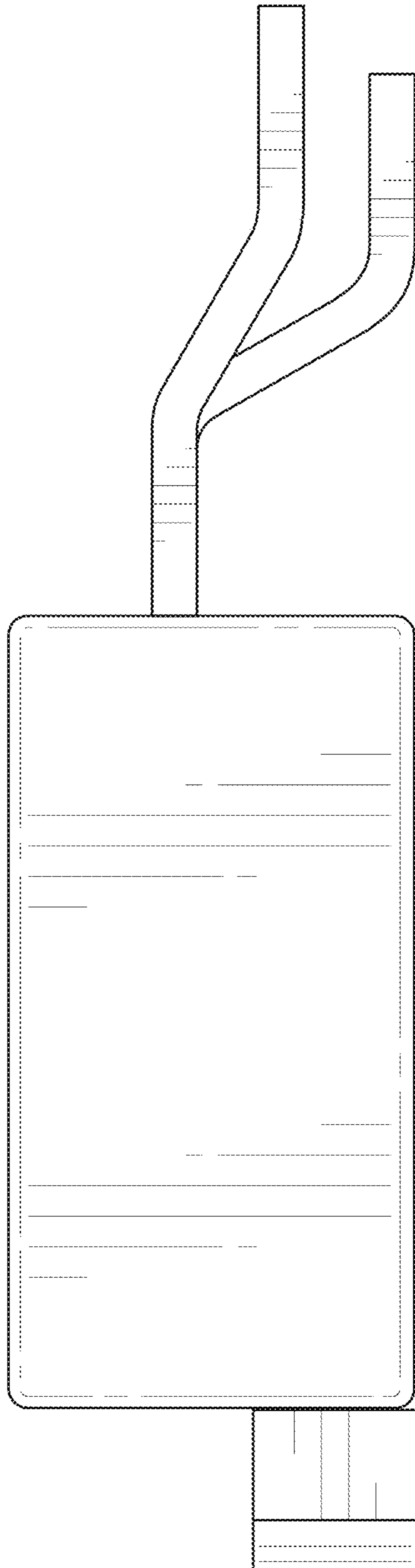


FIG. 2

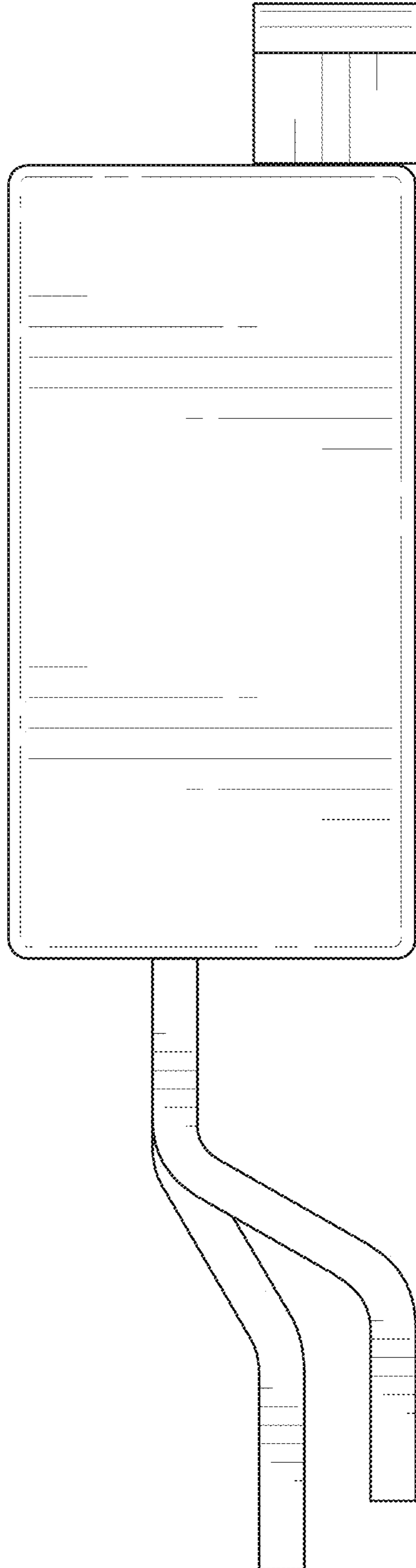


FIG. 3

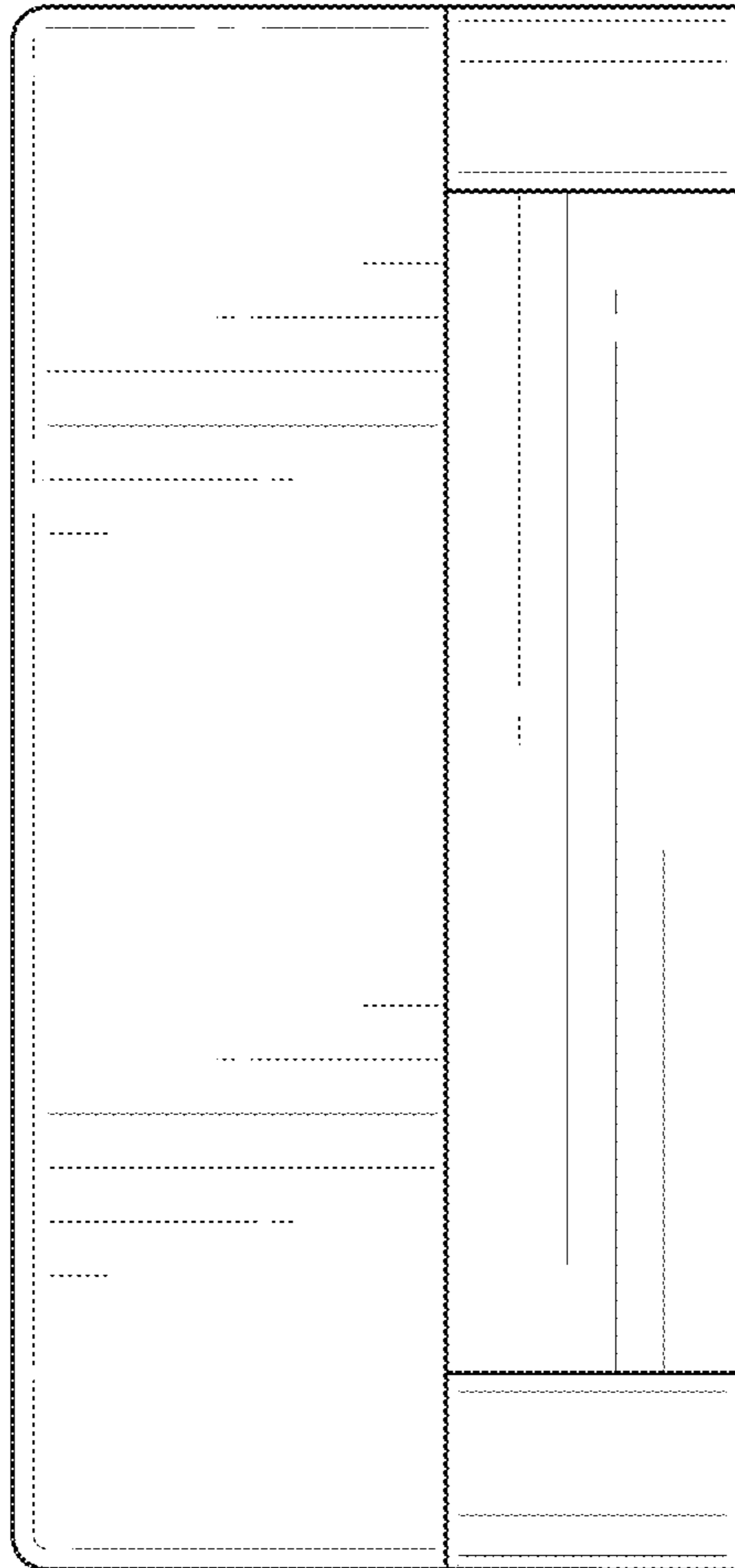


FIG. 4

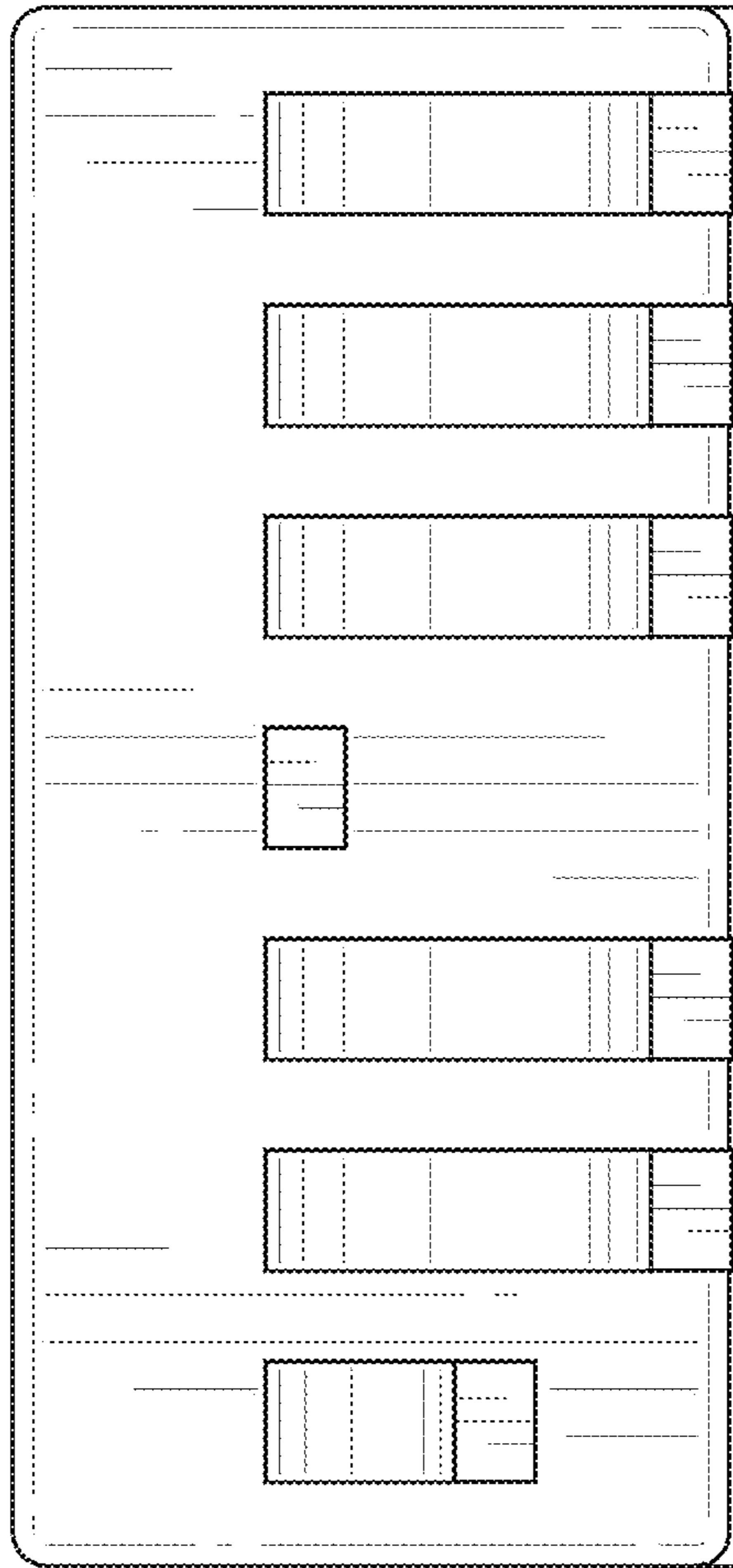


FIG. 5

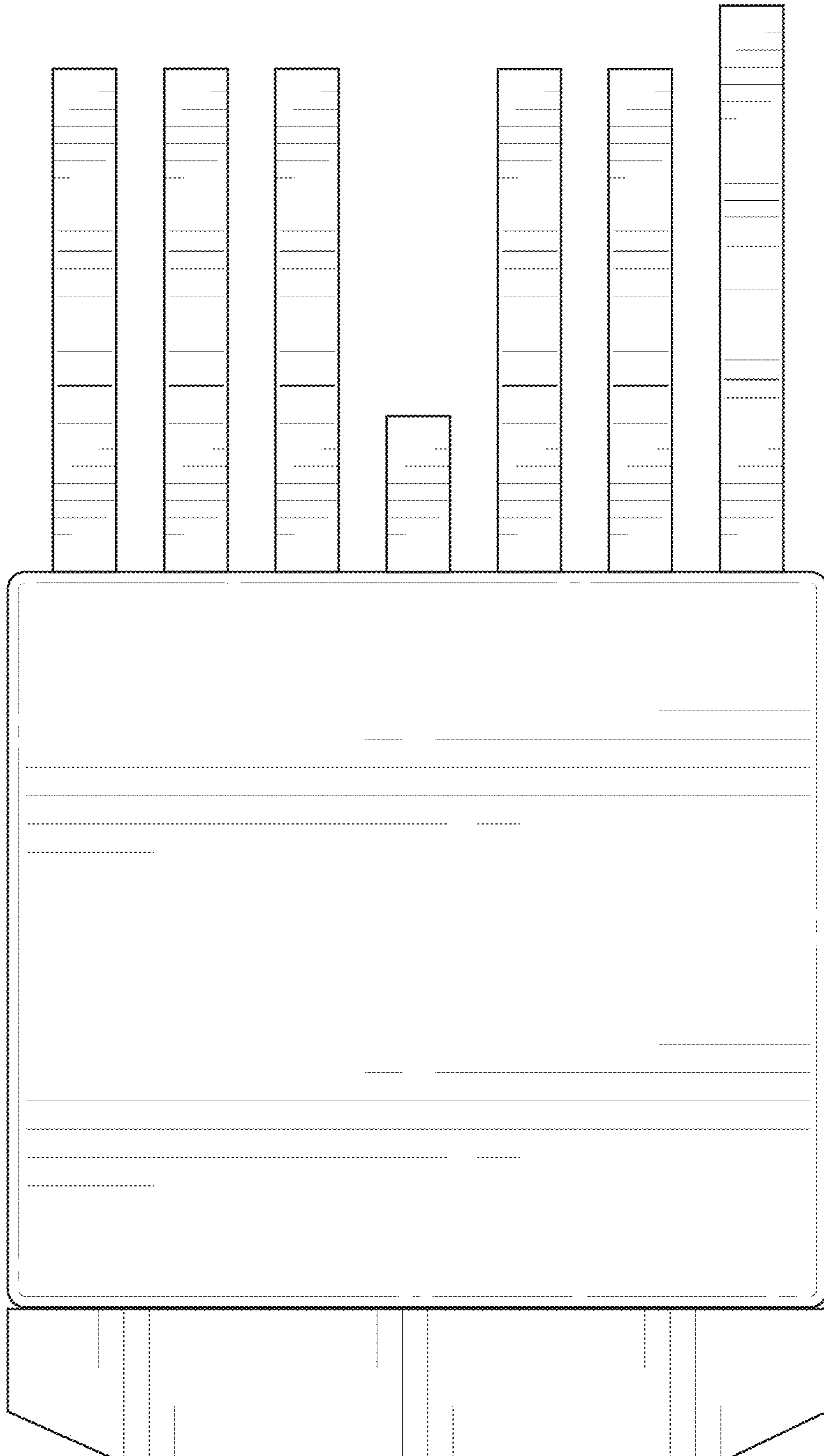


FIG. 6

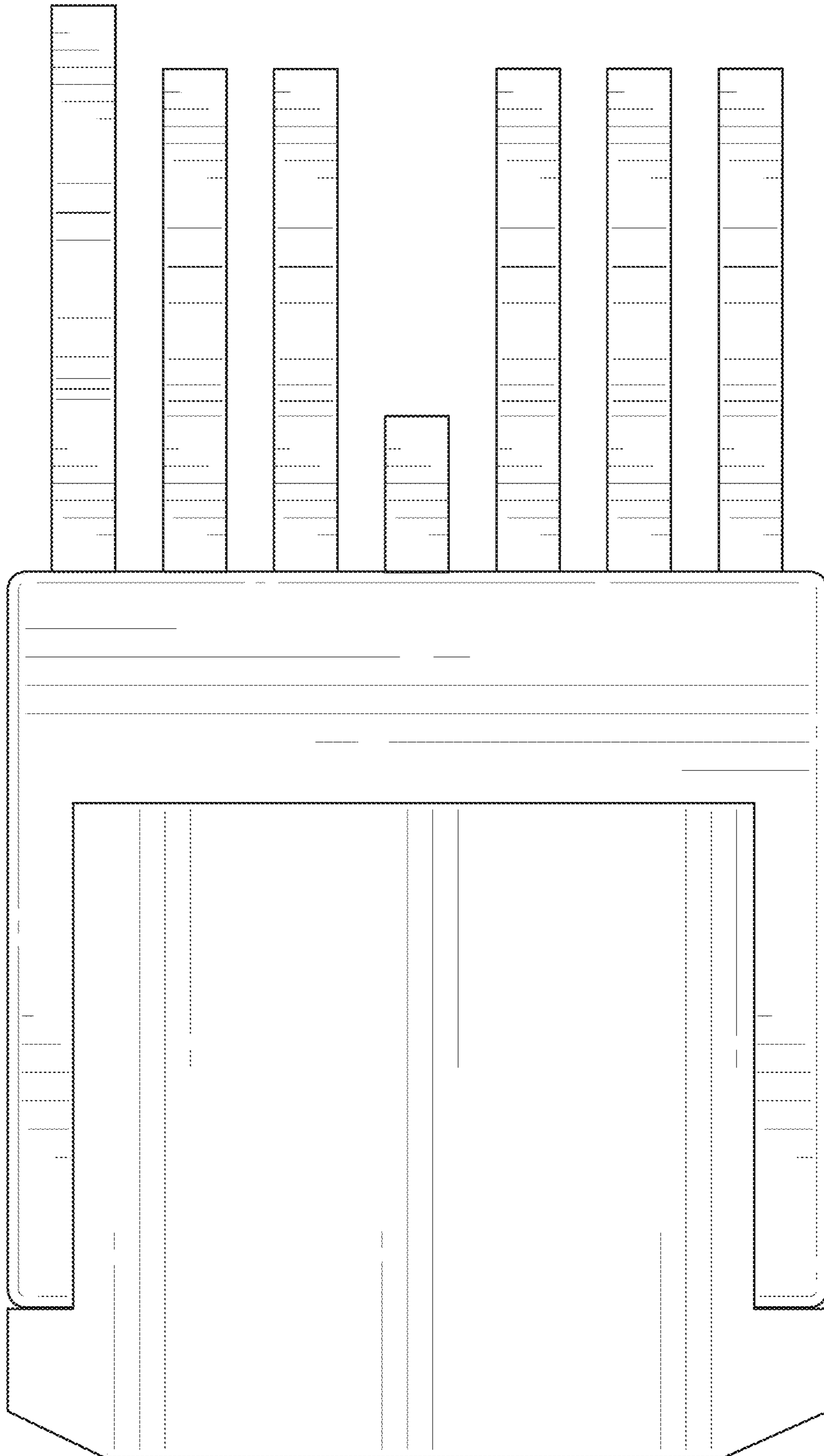


FIG. 7